



**MOLD-TEK**  
Packaging Limited

MTPL/SECT/02/2026-27

Date: April 15, 2026

To The Secretary, Listing Department, <b>BSE Limited,</b> Phiroze Jeejeebhoy Towers, Dalal Street, Fort, Mumbai-400001. <b>Scrip Code: 533080</b>	To The Manager, Listing Department, <b>National Stock Exchange of India Limited,</b> Exchange Plaza, 5 <sup>th</sup> Floor, Plot No. C/1, G Block, Bandra Kurla Complex, Bandra (E), Mumbai-400051. <b>Symbol: MOLDTKPAC</b>
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Dear Sir/Madam,

**Sub: Intimation of Board Meeting**

Pursuant to Regulation 29 of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015 (“SEBI Listing Regulations”), as amended, we hereby inform you that, a meeting of the Board of Directors of the Company is scheduled to be held on Monday, April 20, 2026, to consider, inter-alia, declaration of First Interim Dividend for the Financial Year 2025-26.

The Record date for the purpose of ascertaining the eligibility of members for payment of interim dividend, if declared, by the Board of Directors of the Company, has been fixed as Friday, April 24, 2026.

Further to our letter dated March 29, 2026, the Company has closed its trading window with effect from April 01, 2026 till the end of 48 hours after the declaration of audited Financial Results of the Company for the quarter and year ended on March 31, 2026.

This is for your kind information and records.

Thanking you,

Yours faithfully,

**For Mold-Tek Packaging Limited**

**Harshita Suresh Chandnani**  
**Company Secretary and Compliance Officer**